



- ★ Super Low Gate Charge
- ★ 100% EAS Guaranteed
- ★ Green Device Available
- ★ Excellent CdV/dt effect decline
- ★ Advanced high cell density Trench technology

Product Summary

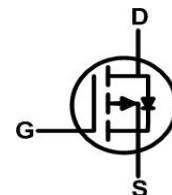
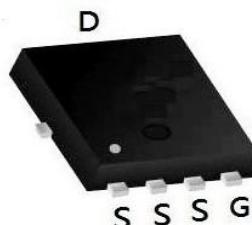
| BVDSS | RDS(ON) | ID |
|-------|---------|-------|
| -40V | 4.3mΩ | -80 A |

Description

The XR80P04F is the high cell density trenched P-ch MOSFETs, which provide excellent RDS(ON) and gate charge for most of the synchronous buck converter applications.

The XR80P04F meet the RoHS and Green Product requirement, 100% EAS guaranteed with full function reliability approved.

PDFN5060-8L Pin Configuration



Absolute Maximum Ratings

| Symbol | Parameter | Rating | Units |
|---------------------------|---|------------|-------|
| V_{DS} | Drain-Source Voltage | -40 | V |
| V_{GS} | Gate-Source Voltage | ± 20 | V |
| $I_D @ T_C = 25^\circ C$ | Continuous Drain Current, $V_{GS} @ -10V^{1,6}$ | -80 | A |
| $I_D @ T_C = 100^\circ C$ | Continuous Drain Current, $V_{GS} @ -10V^{1,6}$ | -56 | A |
| I_{DM} | Pulsed Drain Current ² | -320 | A |
| EAS | Single Pulse Avalanche Energy ³ | 576 | mJ |
| I_{AS} | Avalanche Current | -56 | A |
| $P_D @ T_C = 25^\circ C$ | Total Power Dissipation ⁴ | 58 | W |
| T_{STG} | Storage Temperature Range | -55 to 175 | °C |
| T_J | Operating Junction Temperature Range | -55 to 175 | °C |

Thermal Data

| Symbol | Parameter | Typ. | Max. | Unit |
|-----------------|---|------|------|------|
| $R_{\theta JA}$ | Thermal Resistance Junction-ambient ¹ ($t \leq 10S$) | --- | 20 | °C/W |
| | Thermal Resistance Junction-ambient ¹ (Steady State) | --- | 50 | °C/W |
| $R_{\theta JC}$ | Thermal Resistance Junction-case ¹ | --- | 1.6 | °C/W |

P-Ch 40V Fast Switching MOSFETs

Electrical Characteristics ($T_J=25^\circ\text{C}$, unless otherwise noted)

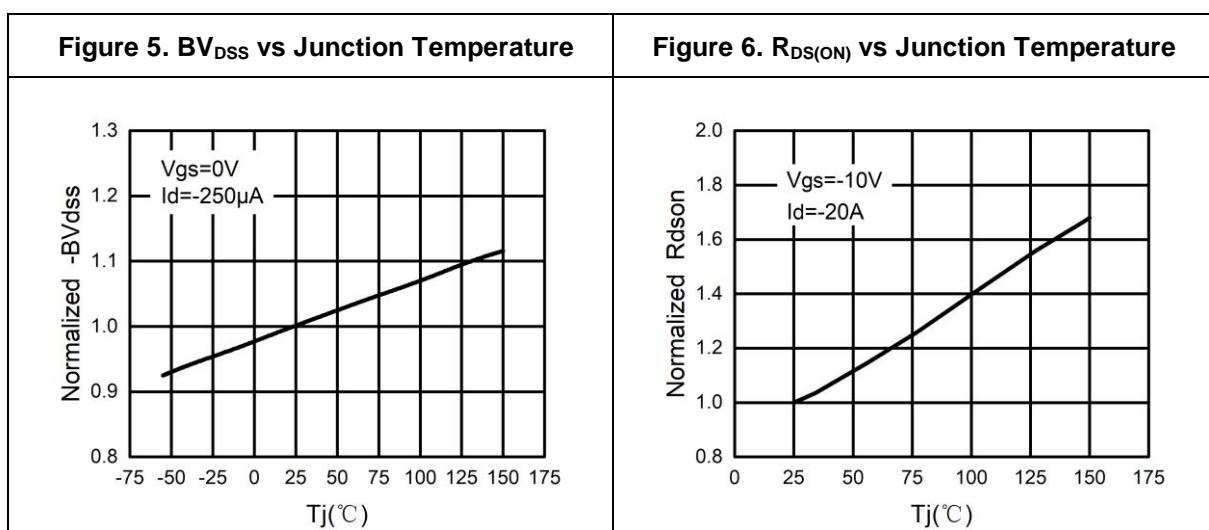
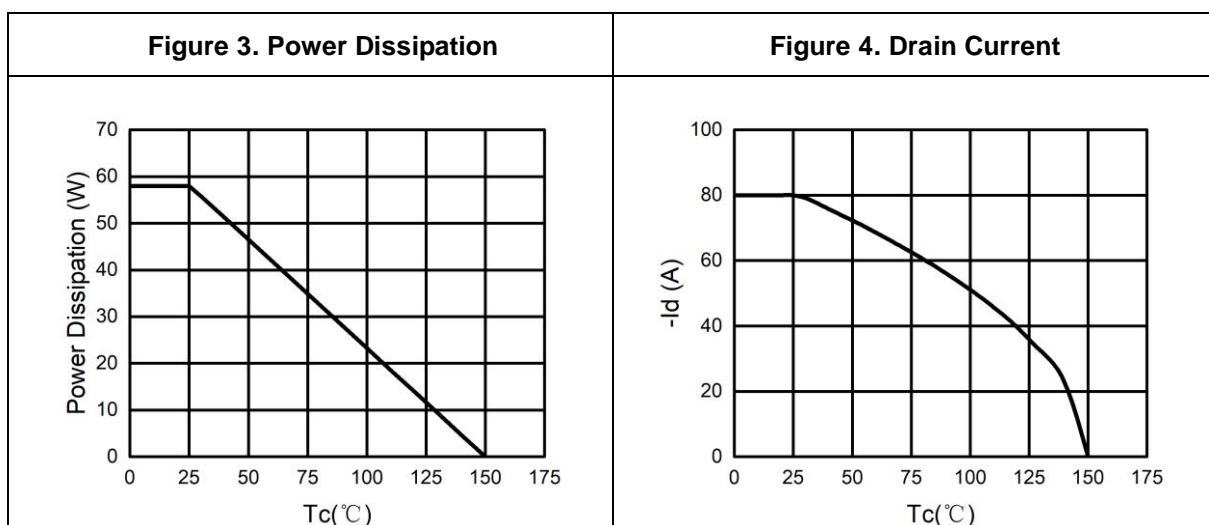
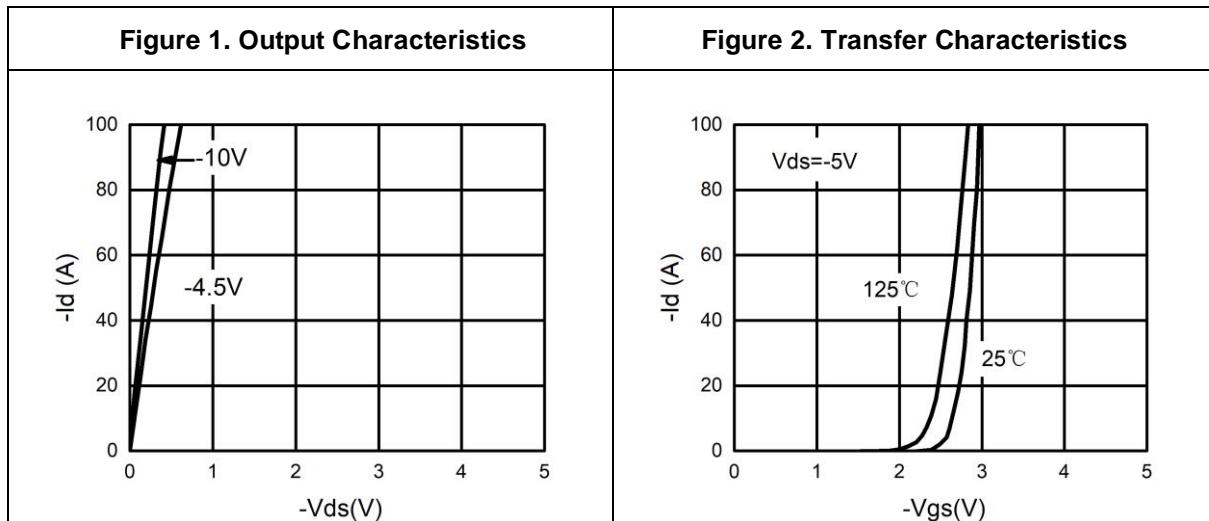
| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|---|-----------------------------------|---|-----|------|----------|------------------|
| On/Off States | | | | | | |
| BV_{DSS} | Drain-Source Breakdown Voltage | $V_{\text{GS}}=0\text{V}$, $I_{\text{D}}=-250\mu\text{A}$ | -40 | | | V |
| $I_{\text{DS}(\text{S})}$ | Zero Gate Voltage Drain Current | $V_{\text{DS}}=-40\text{V}$, $V_{\text{GS}}=0\text{V}$ | | | -1 | μA |
| I_{GSS} | Gate-Body Leakage Current | $V_{\text{GS}}=\pm20\text{V}$, $V_{\text{DS}}=0\text{V}$ | | | ±100 | nA |
| $V_{\text{GS}(\text{th})}$ | Gate Threshold Voltage | $V_{\text{DS}}=V_{\text{GS}}$, $I_{\text{D}}=-250\mu\text{A}$ | -1 | -1.7 | -2.5 | V |
| g_{FS} | Forward Transconductance | $V_{\text{DS}}=-5\text{V}$, $I_{\text{D}}=-20\text{A}$ | | 63 | | S |
| $R_{\text{DS}(\text{ON})}$ | Drain-Source On-State Resistance | $V_{\text{GS}}=-10\text{V}$, $I_{\text{D}}=-20\text{A}$ | | 4.3 | 5.3 | $\text{m}\Omega$ |
| | | $V_{\text{GS}}=-4.5\text{V}$, $I_{\text{D}}=-20\text{A}$ | | 5.9 | 7.6 | $\text{m}\Omega$ |
| Dynamic Characteristics | | | | | | |
| C_{iss} | Input Capacitance | $V_{\text{DS}}=-20\text{V}$, $V_{\text{GS}}=0\text{V}$, $f=1.0\text{MHz}$ | | 6638 | | pF |
| C_{oss} | Output Capacitance | | | 545 | | pF |
| C_{rss} | Reverse Transfer Capacitance | | | 345 | | pF |
| R_g | Gate resistance | $V_{\text{GS}}=0\text{V}$, $V_{\text{DS}}=0\text{V}$, $f=1.0\text{MHz}$ | | 2.2 | | Ω |
| Switching Parameters | | | | | | |
| $t_{\text{d}(\text{on})}$ | Turn-on Delay Time | $V_{\text{GS}}=-10\text{V}$, $V_{\text{DS}}=-20\text{V}$, $R_L=1\Omega$, $R_{\text{GEN}}=3\Omega$ | | 16 | | nS |
| t_r | Turn-on Rise Time | | | 17 | | nS |
| $t_{\text{d}(\text{off})}$ | Turn-Off Delay Time | | | 68 | | nS |
| t_f | Turn-Off Fall Time | | | 31 | | nS |
| Q_g | Total Gate Charge | $V_{\text{GS}}=-10\text{V}$, $V_{\text{DS}}=-20\text{V}$, $I_{\text{D}}=-20\text{A}$ | | 118 | | nC |
| Q_{gs} | Gate-Source Charge | | | 13 | | nC |
| Q_{gd} | Gate-Drain Charge | | | 22 | | nC |
| Source-Drain Diode Characteristics | | | | | | |
| I_{SD} | Source-Drain Current (Body Diode) | | | | -80 | A |
| V_{SD} | Forward on Voltage (Note 3) | $V_{\text{GS}}=0\text{V}$, $I_{\text{S}}=-20\text{A}$ | | | -1.2 | V |
| t_{rr} | Reverse Recovery Time | $I_F=-20\text{A}$, $dI/dt=500\text{A}/\mu\text{s}$ | | 24 | | ns |
| Q_{rr} | Reverse Recovery Charge | $I_F=-20\text{A}$, $dI/dt=500\text{A}/\mu\text{s}$ | | 140 | | nC |

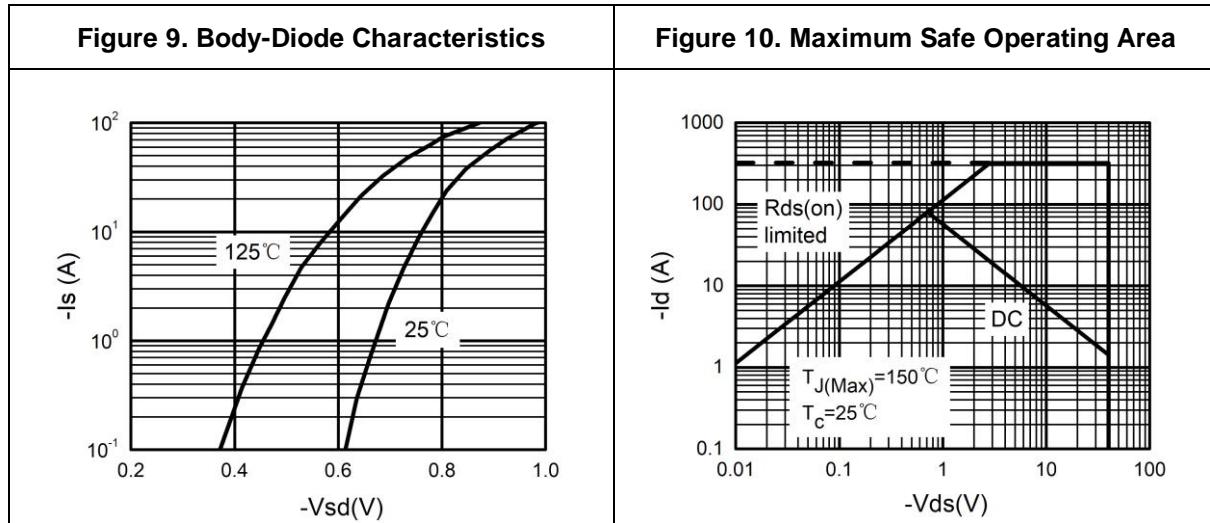
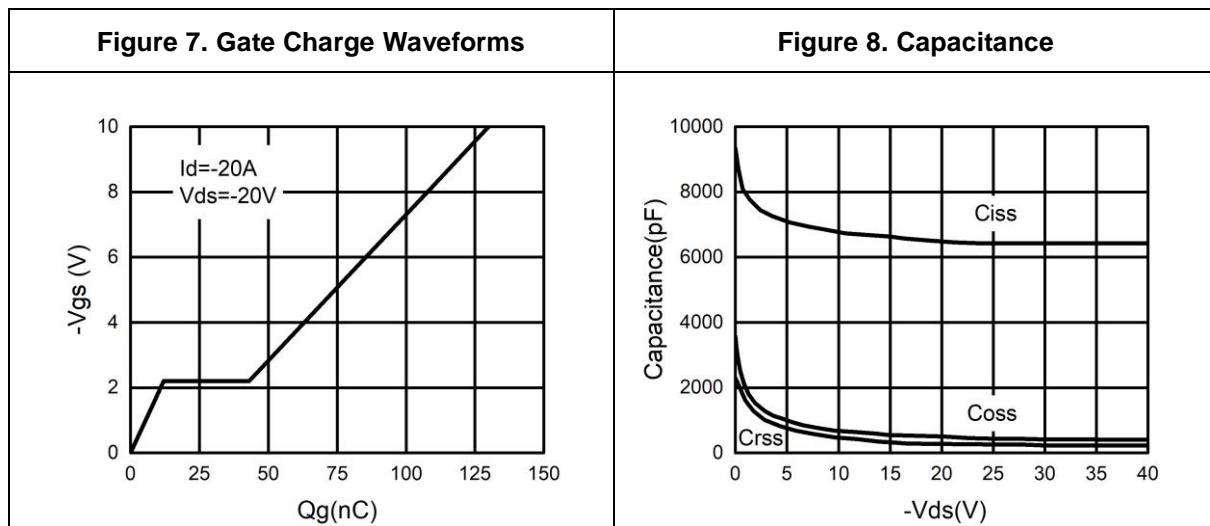
Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature.

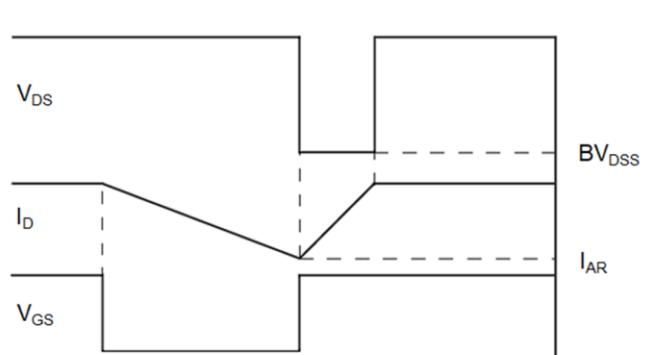
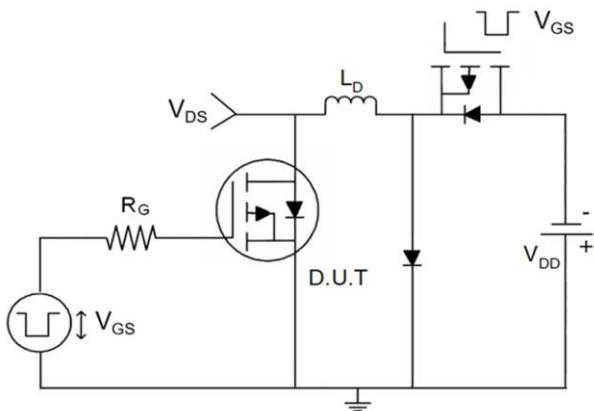
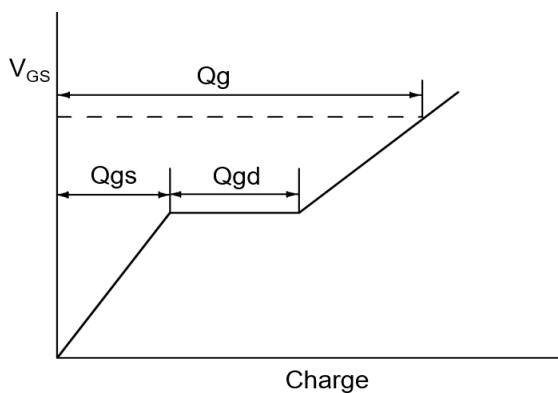
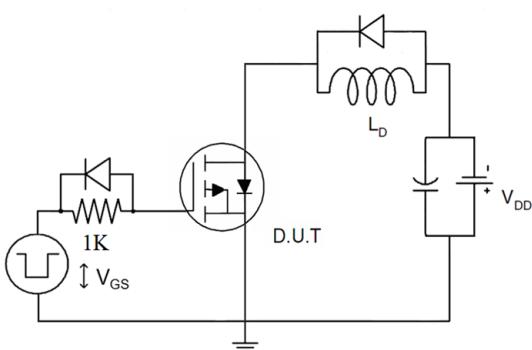
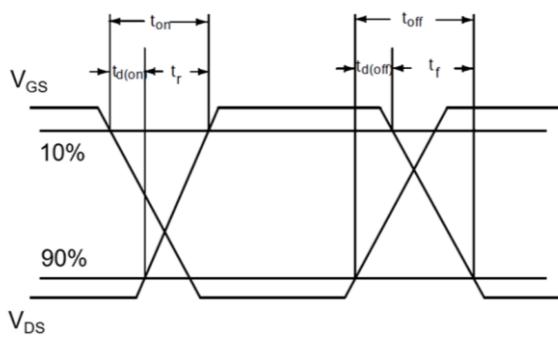
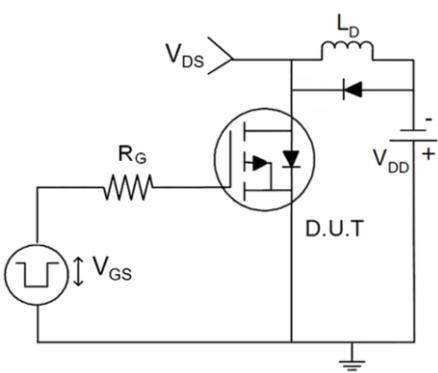
Notes 2.E_{AS} condition: $T_J=25^\circ\text{C}$, $V_{\text{DD}}=15\text{V}$, $V_G=-10\text{V}$, $R_g=25\Omega$, $L=0.5\text{mH}$.

Notes 3.Repetitive Rating: Pulse width limited by maximum junction temperature.

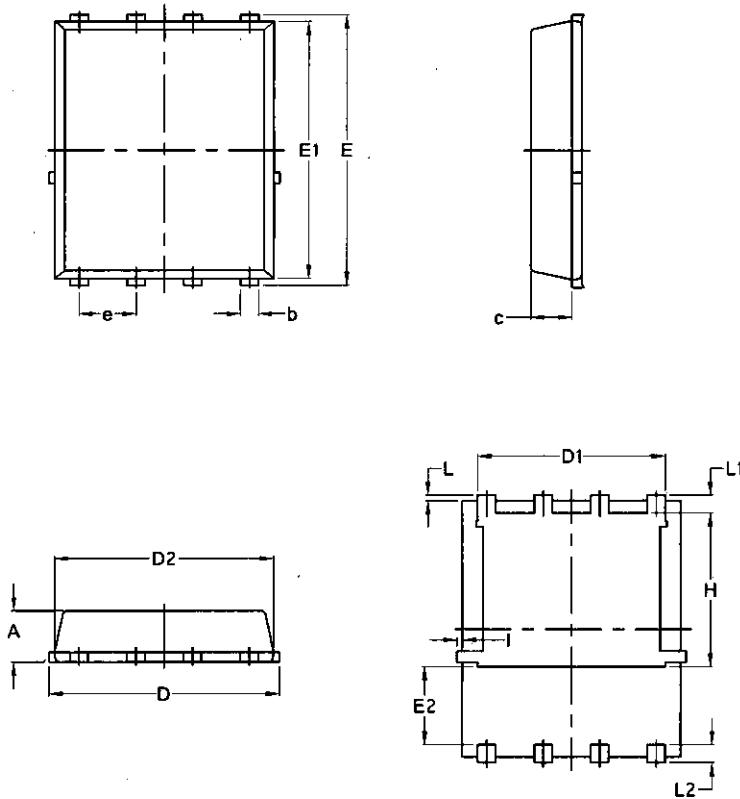
Typical Electrical And Thermal Characteristics (Curves)





Test Circuit**P-Ch 40V Fast Switching MOSFETs****1) E_{AS} Test Circuits****2) Gate Charge Test Circuit****3) Switch Time Test Circuit**

Package Mechanical Data-PDFN5060-8L-JQ Single



| Symbol | Common | | | |
|--------|----------|--------|----------|--------|
| | mm | | Inch | |
| | Mim | Max | Min | Max |
| A | 1.03 | 1.17 | 0.0406 | 0.0461 |
| b | 0.34 | 0.48 | 0.0134 | 0.0189 |
| c | 0.824 | 0.0970 | 0.0324 | 0.082 |
| D | 4.80 | 5.40 | 0.1890 | 0.2126 |
| D1 | 4.11 | 4.31 | 0.1618 | 0.1697 |
| D2 | 4.80 | 5.00 | 0.1890 | 0.1969 |
| E | 5.95 | 6.15 | 0.2343 | 0.2421 |
| E1 | 5.65 | 5.85 | 0.2224 | 0.2303 |
| E2 | 1.60 | / | 0.0630 | / |
| e | 1.27 BSC | | 0.05 BSC | |
| L | 0.05 | 0.25 | 0.0020 | 0.0098 |
| L1 | 0.38 | 0.50 | 0.0150 | 0.0197 |
| L2 | 0.38 | 0.50 | 0.0150 | 0.0197 |
| H | 3.30 | 3.50 | 0.1299 | 0.1378 |
| I | / | 0.18 | / | 0.0070 |